



IPAD™

EMIF04-10006F1

4 LINES EMI FILTER AND ESD PROTECTION

MAIN PRODUCT CHARACTERISTICS

Where EMI filtering in ESD sensitive equipment is required:

- Mobile phones and communication systems
- Computers, printers and MCU Boards

DESCRIPTION

The EMIF04-10006F1 is a highly integrated devices designed to suppress EMI/RFI noise in all systems subjected to electromagnetic interferences. The EMIF04 flip-chip packaging means the package size is equal to the die size.

This filter includes an ESD protection circuitry which prevents the device from destruction when subjected to ESD surges up 15kV. This device includes four EMIF filters and 4 separated ESD diodes.

BENEFITS

- EMI symmetrical (I/O) low-pass filter
- High efficiency in EMI filtering
- Very low PCB space consuming:
2.92mm x 1.29mm
- Very thin package: 0.65 mm
- High efficiency in ESD suppression
(IEC61000-4-2 level 4)
- High reliability offered by monolithic integration
- High reducing of parasitic elements through integration and wafer level packaging.

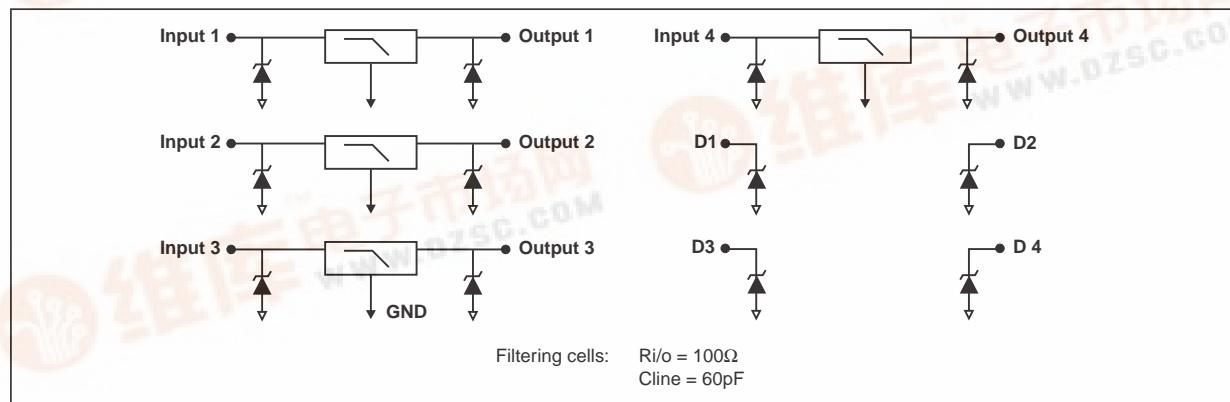
COMPLIES WITH THE FOLLOWING STANDARDS :

IEC 61000-4-2 level 4:

15kV (air discharge)
8 kV (contact discharge)

MIL STD 883E - Method 3015-6 Class 3

BASIC CELL CONFIGURATION



TM : IPAD is a trademark of STMicroelectronics.

January 2003 - Ed: 1

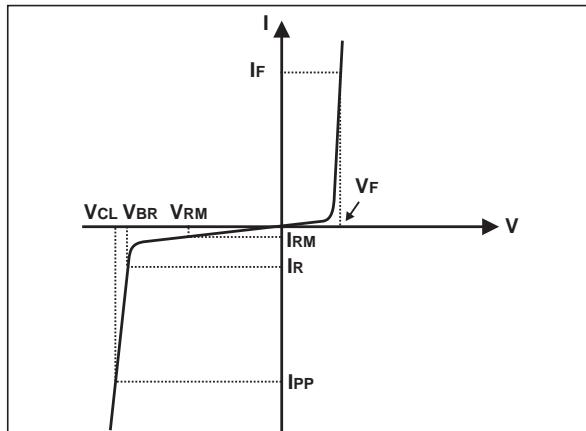
EMIF04-10006F1

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter and test conditions	Value	Unit
P_R	DC power per resistance	0.1	W
P_T	Total DC power per package	0.6	W
T_j	Maximum junction temperature	125	°C
T_{op}	Operating temperature range	-40 to + 85	°C
T_{stg}	Storage temperature range	125	°C

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25$ °C)

Symbol	Parameter
V_{BR}	Breakdown voltage
I_{RM}	Leakage current @ V_{RM}
V_{RM}	Stand-off voltage
V_{CL}	Clamping voltage
R_d	Dynamic impedance
I_{PP}	Peak pulse current
$R_{I/O}$	Series resistance between Input and Output
C_{line}	Input capacitance per line



Symbol	Test conditions	Min.	Typ.	Max.	Unit
V_{BR}	$I_R = 1$ mA	5.5	7	9	V
I_{RM}	$V_{RM} = 3.3$ V per line			500	nA
$R_{I/O}$	$I = 10$ mA	80	100	120	Ω
C_{line}	$V_R = 2.5$ V, $F = 1$ MHz, 30 mV (on filter cells)	50	60	70	pF

Fig. 1: S21 (dB) attenuation measurements and Aplac simulation.

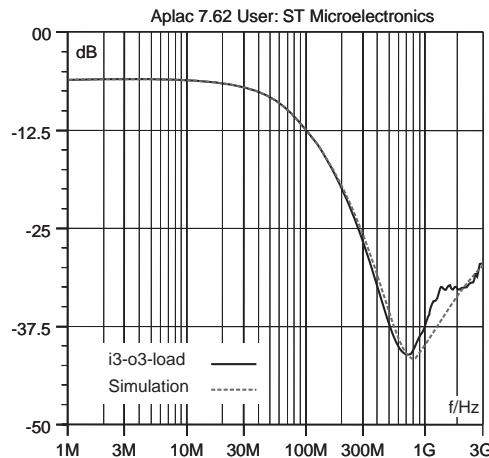


Fig. 3: Digital crosstalk measurements.

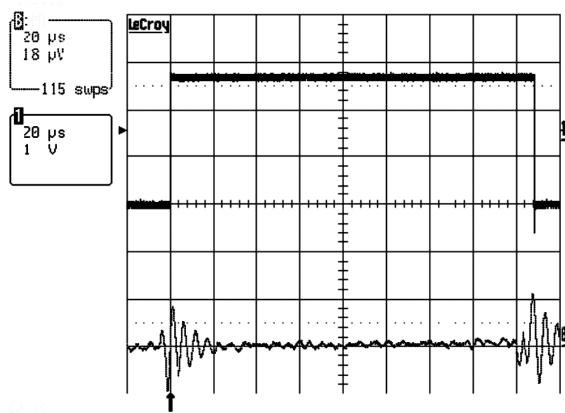


Fig. 5: ESD response to IEC61000-4-2 (-15kV air discharge) on one input V(in) and one output V(out).

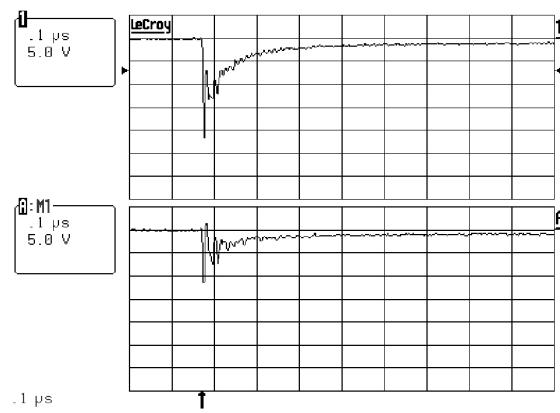


Fig. 2: Analog crosstalk measurements.

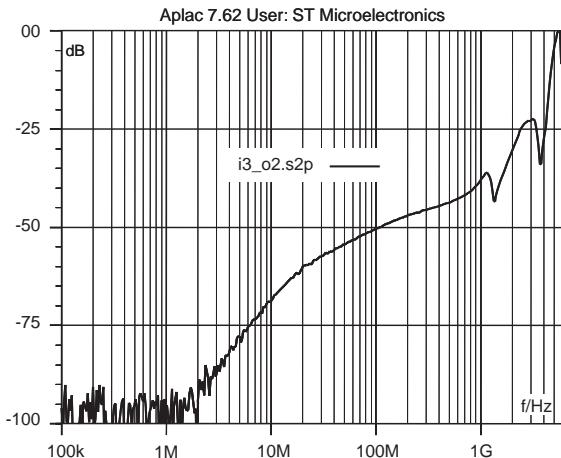


Fig. 4: ESD response to IEC61000-4-2 (+15kV air discharge) on one input V(in) and one output V(out).

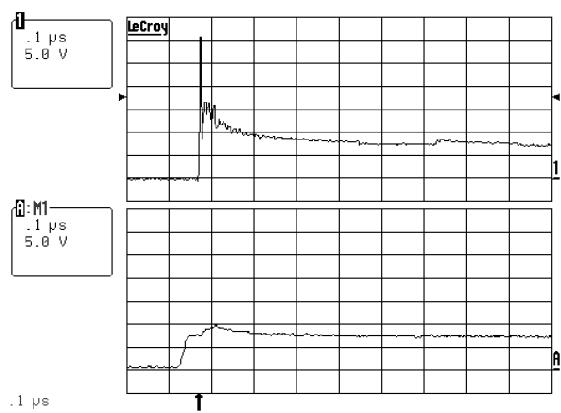
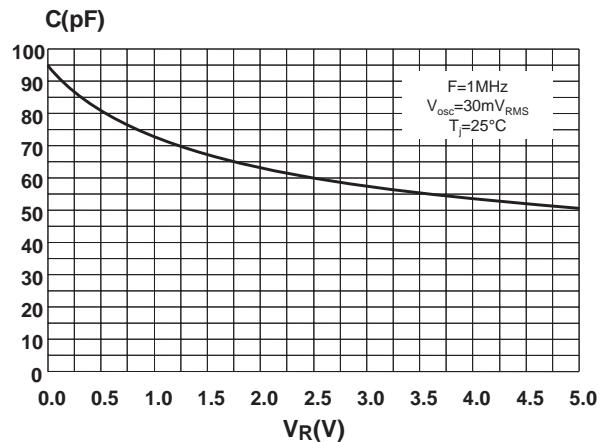
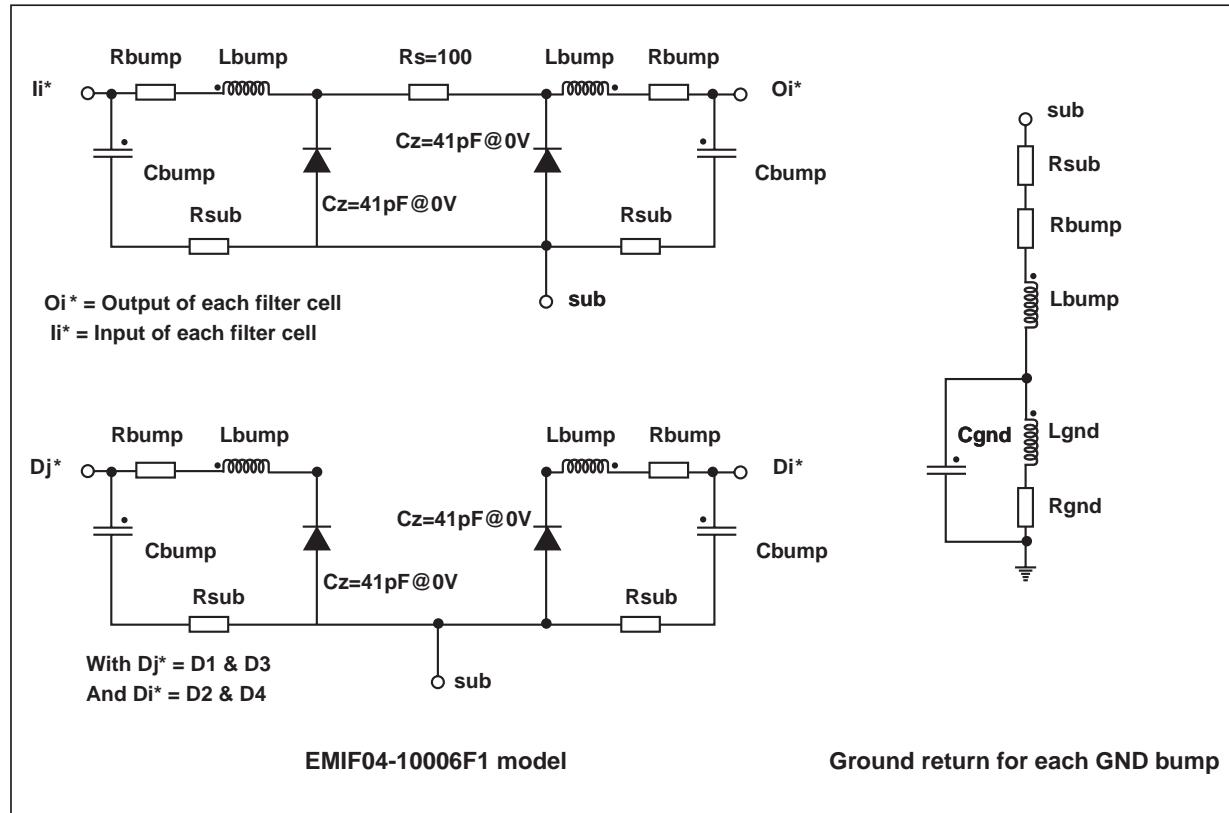


Fig. 6: Line capacitance versus applied voltage for filter.



EMIF04-10006F1

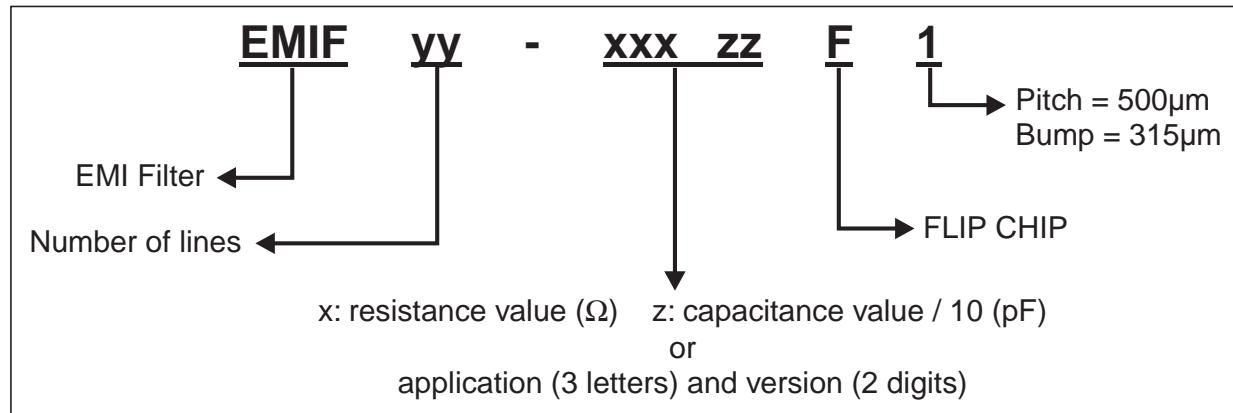
Aplac model



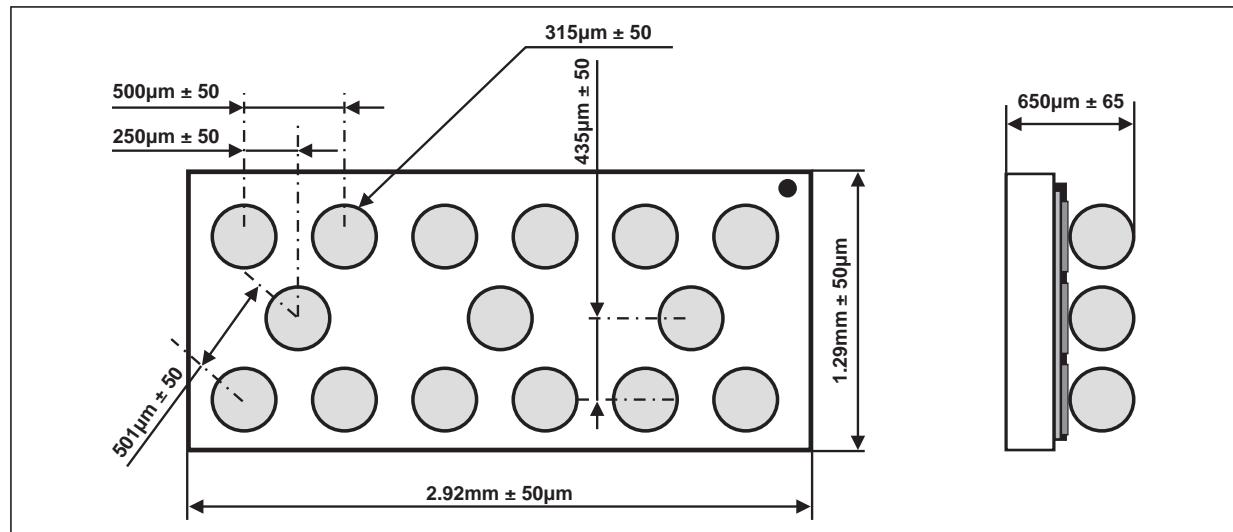
Aplac parameters

aplacvar Rs	100Ω
aplacvar Cz	41 pF
aplacvar Lbump	50 pH
aplacvar Rbump	20 m
aplacvar Cbump	1.2 pF
aplacvar Rsub	100 m
aplacvar Rgnd	100 m
aplacvar Lgnd	100 pH
aplacvar Cgnd	0.15 pF

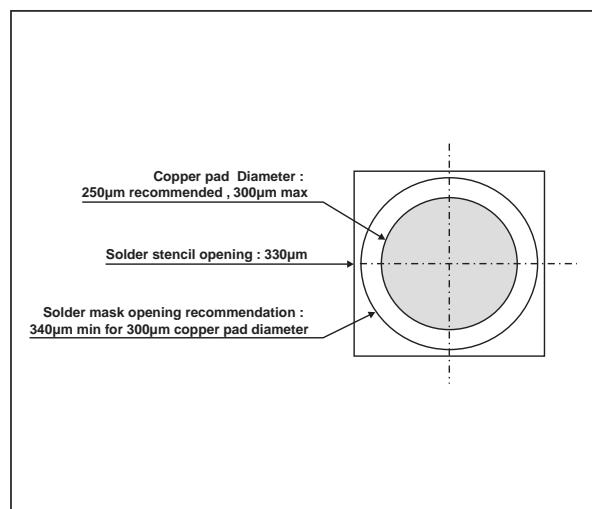
ORDER CODE



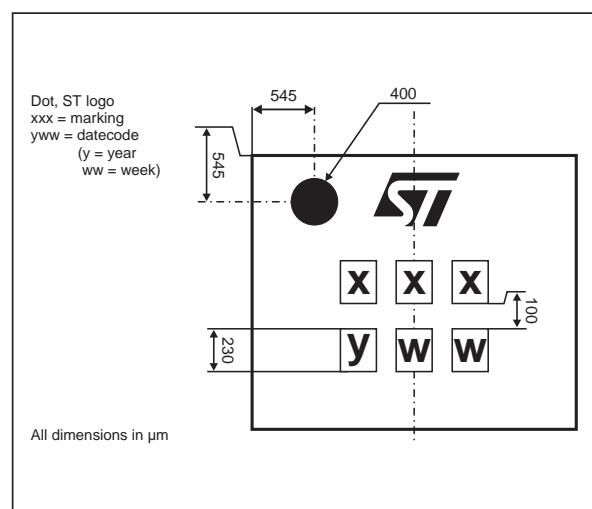
PACKAGE MECHANICAL DATA



FOOT PRINT RECOMMENDATIONS

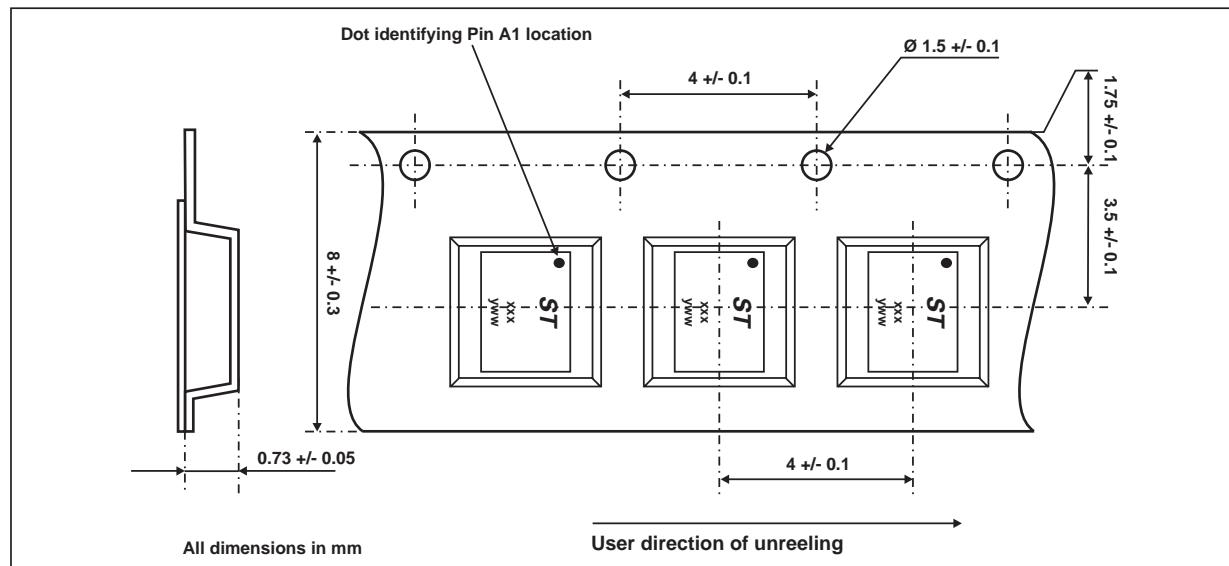


MARKING



EMIF04-10006F1

FLIP-CHIP TAPE AND REEL SPECIFICATION



OTHER INFORMATION

Ordering code	Marking	Package	Weight	Base qty	Delivery mode
EMIF04-10006F1	FST	Flip-Chip	5.4 mg	5000	Tape & reel

Note: More packing informations are available in the application note AN1235: "Flip-Chip: Package description and recommendations for use"

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied.
STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics

© 2003 STMicroelectronics - Printed in Italy - All rights reserved.

STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - Canada - China - Finland - France - Germany

Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore

Spain - Sweden - Switzerland - United Kingdom - United States.

<http://www.st.com>